



MAX13170E/MAX13172E/MAX13174E Evaluation Kit

General Description

The MAX13170E/MAX13172E/MAX13174E evaluation kit (EV kit) combines the MAX13170E multiprotocol clock/data transceiver, the MAX13172E control transceiver, and the MAX13174E cable terminator chips. This chipset forms a complete software-selectable multiprotocol data terminal equipment (DTE) or data communications equipment (DCE) interface port that supports the V.28 (RS-232), V.11 (RS-449/V.36, EIA-530, EIA-530A, and X.21), and V.35 protocols. Internal charge pumps allow the EV kit to operate off a single 5V supply.

The EV kit was designed to take advantage of the chipset's flow-through pinout. The EV kit includes a 40-pin header (logic signals), a female DB25 connector (protocol signals), three SMA connectors (high-speed logic signals), and scope-probe connectors for measuring the high-speed data signals (logic and protocol signals).

Features

- ◆ Programmable Transceiver Supports
 - V.28 (RS-232)
 - V.11 (RS-449/V.36, EIA-530, EIA-530A, and X.21)
 - V.35
- ◆ True Fail-Safe Receiver Inputs
- ◆ Programmable Cable Termination (MAX13174E)
- ◆ Proven PCB Layout
- ◆ Fully Assembled and Tested

Ordering Information

PART	TYPE
MAX13170EEVKIT+ or MAX13172EEVKIT+ or MAX13174EEVKIT+	EV Kit

+Denotes lead(Pb)-free and RoHS compliant.

Note: The MAX13170E/MAX13172E/MAX13174E EV kit can be ordered using any of the part numbers above.

Component List

DESIGNATION	QTY	DESCRIPTION
C1, C2, C9–C13	7	1µF ±10%, 10V X5R ceramic capacitors (0805) Murata GRM219R61A105M
C3, C4	2	4.7µF ±10%, 10V X5R ceramic capacitors (1206) Murata GRM31CR61A475K
C5	1	4.7µF 10%, 16V X7R ceramic capacitor (0805) Murata GRM21BR71C475K
C6, C7, C8	3	100pF ±5%, 50V C0G ceramic capacitors (0603) Murata GQM1885C1H101J
C14, C15	2	0.1µF ±10%, 16V X5R ceramic capacitors (0603) Murata GRM188R61C104K

DESIGNATION	QTY	DESCRIPTION
C16	1	0.1µF ±10%, 16V X7R ceramic capacitor (0805) Murata GRM219R71C104K
C17	1	47µF ±10%, 16V tantalum capacitor (D case) AVX TPSD476M016R0150
D1–D6	6	Red LEDs
D7–D12	6	Green LEDs
D13–D16	4	Yellow LEDs
J1	1	40-pin (2 x 20) header
J2	1	DB25 right-angle female connector
J3, J4, J5	3	SMA connectors (PC edge mount)
JU1–JU7	7	3-pin headers

**Evaluates:
MAX13170E/MAX13172E/MAX13174E**

MAX13170E/MAX13172E/MAX13174E

Evaluation Kit

Component List (continued)

DESIGNATION	QTY	DESCRIPTION
JU8–JU12, JU13–JU17	10	2-pin headers
N/A TXC, RXC SCTE, RXCA SCTEA, RXCB SCTEB, RXD TXD, RXDA TXDA, RXDB TXDB, SCTE RXC, SCTEA RXCA, SCTEB RXCB, TXC N/A, TXCA TXCA, TXCB TXCB, TXD RXD, TXDA RXDA, TXDB RXDB	16	Scope-probe connectors (top mount, 3.5mm ground cylinder)

DESIGNATION	QTY	DESCRIPTION
R1, R2, R3	3	49.9Ω ±1% resistors (0805)
R4–R19	16	1.5kΩ ±5% resistors (0805)
TP1, TP2	2	Red test points
U1	1	Clock/data transceiver (28 SSOP) Maxim MAX13170ECAI+
U2	1	Clock transceiver (28 SSOP) Maxim MAX13172ECAI+
U3	1	Cable terminator (24 SSOP) Maxim MAX13174ECAG+
U4, U5	2	Inverting LED drivers (20 Wide SO)
—	17	Shunts
—	1	PCB: MAX13170E/13172E/ 13174E EVALUATION KIT+

Component Suppliers

SUPPLIER	PHONE	WEBSITE
AVX Corporation	843-946-0238	www.avxcorp.com
Murata Electronics North America, Inc.	770-436-1300	www.murata-northamerica.com

Note: Indicate that you are using the MAX13170E, MAX13172E, or MAX13174E when contacting these component suppliers.

Quick Start

Required Equipment

- MAX13170E/MAX13172E/MAX13174E EV kit
- 5V DC power supply

Procedure

The EV kit is fully assembled and tested. Follow the steps below to verify board operation. **Caution: Do not turn on power supplies until all connections are completed.**

- 1) Verify that the default settings are configured correctly, as shown in Tables 1, 2, and 3.
- 2) Connect a single 5V ±5% power supply between the VCC and GND pads located in the lower-left corner of the EV kit board.
- 3) The yellow LEDs indicate the protocol mode of the chipset. The LEDs light up when the corresponding signal is a logic-high. Verify that all yellow LEDs

light up indicating no-cable mode. All board labels, including all the labels for the LEDs, follow the same label format. The board label format top label corresponds to DCE mode and the bottom label corresponds to DTE mode.

- 4) The green LEDs are attached to the receiver logic outputs of the MAX13170E (U1) and the MAX13172E (U2). The LEDs light up when the receiver logic outputs are a logic-high. Verify that all green LEDs light up when no signals are attached to the DB25 connector. **Note:** The receivers have the true fail-safe feature allowing 0V differential voltage to be a valid state that forces the receiver outputs high.
- 5) The red LEDs are attached to the transmitter logic inputs of U1 and U2. The LEDs light up when the transmitter logic inputs are a logic-high. Verify that none of the red LEDs light up when no signals are connected to the 40-pin header (J1).

MAX13170E/MAX13172E/MAX13174E **Evaluation Kit**

Evaluates:

MAX13170E/MAX13172E/MAX13174E

Detailed Description of Hardware

The MAX13170E/MAX13172E/MAX13174E EV kit was designed to take advantage of the chipset's flow-through pinout. The logic signals have all been routed to the 40-pin header (J1) located on the left side of the EV kit board. The protocol signals have all been routed to the female DB25 connector (J2) located on the right side of the board.

Various connectors have been added to the EV kit to aid in taking quality measurements. Leave JU17 unconnected when measuring the supply current of the chipset. Scope-probe connectors have been added to measure the high-speed signals of the transmitter inputs/outputs and receiver inputs/outputs of the MAX13170E. The scope-probe connectors located on the left side of the board are connected to the logic input and output signals. The scope-probe connectors located on the right side of the board are connected to the protocol input and output signals.

Three SMA connectors (J3, J4, and J5) have also been provided for driving the high-speed transmitter inputs of the MAX13170E. The string of 16 LEDs across the top of the board (D1–D16) are logic indicators. The red LEDs (D1–D6) indicate the state of the transmitter inputs of the MAX13170E and MAX13172E, the green LEDs (D7–D12) indicate the state of the receiver outputs, and the yellow LEDs (D13–D16) indicate the state of the protocol and the protocol-termination modes. The LEDs light up when their corresponding signals are a logic-high.

The EV kit is extremely flexible and has several settings for both the ICs as well as the board. The ICs have been put into no-cable mode as the default mode. In no-cable mode the user is able to program the desired protocol with an external controller connected to the 40-pin header. The default mode settings are shown in Tables 1, 2, and 3. By default the SMA connectors (J3, J4, and J5) are terminated with 50Ω and the control-transmitter input lines are all connected low.

Table 1. MAX13170E Default Mode

MODE	M2	M1	M0	DCE/DTE	T1	T2	T3	R1	R2	R3
No cable	1	1	1	1	Z	Z	Z	Z	Z	Z

Z = High impedance.

Note: Shaded areas share a single IC pin.

Table 2. MAX13172E Default Mode

MODE	M2	M1	M0	DCE/DTE	INVERT	T1	T2	T3	R1	R2	R3	T4	R4
No cable	1	1	1	1	0	Z	Z	Z	Z	Z	Z	Z	Z

Z = High impedance.

Note: Shaded areas share a single IC pin.

Table 3. MAX13174E Default Mode

MODE	M2	M1	M0	DCE/DTE	R1	R2	R3	R4	R5	R6
No cable	1	1	1	1	V.11	V.11	V.11	V.11	V.11	V.11

Table 4. MAX13170E Mode Selection

MODE	M2	M1	M0	DCE/DTE	T1	T2	T3	R1	R2	R3
V.11	0	0	0	0	V.11	V.11	Z	V.11	V.11	V.11
EIA-530A	0	0	1	0	V.11	V.11	Z	V.11	V.11	V.11
EIA-530	0	1	0	0	V.11	V.11	Z	V.11	V.11	V.11
X.21	0	1	1	0	V.11	V.11	Z	V.11	V.11	V.11
V.35	1	0	0	0	V.35	V.35	Z	V.35	V.35	V.35
RS-449/V.36	1	0	1	0	V.11	V.11	Z	V.11	V.11	V.11
V.28/RS-232	1	1	0	0	V.28	V.28	Z	V.28	V.28	V.28
No cable	1	1	1	0	Z	Z	Z	Z	Z	Z
V.11	0	0	0	1	V.11	V.11	V.11	Z	V.11	V.11

MAX13170E/MAX13172E/MAX13174E

Evaluation Kit

Table 4. MAX13170E Mode Selection (continued)

MODE	M2	M1	M0	DCE/DTE	T1	T2	T3	R1	R2	R3
EIA-530A	0	0	1	1	V.11	V.11	V.11	Z	V.11	V.11
EIA-530	0	1	0	1	V.11	V.11	V.11	Z	V.11	V.11
X.21	0	1	1	1	V.11	V.11	V.11	Z	V.11	V.11
V.35	1	0	0	1	V.35	V.35	V.35	Z	V.35	V.35
RS-449/V.36	1	0	1	1	V.11	V.11	V.11	Z	V.11	V.11
V.28/RS-232	1	1	0	1	V.28	V.28	V.28	Z	V.28	V.28
No cable	1	1	1	1	Z	Z	Z	Z	Z	Z

Z = High impedance.

Note: Shaded areas share a single IC pin.

Table 5. MAX13172E Mode Selection

MODE	M2	M1	M0	DCE/DTE	INVERT	T1	T2	T3	R1	R2	R3	T4	R4
V.11	0	0	0	0	0	V.11	V.11	Z	V.11	V.11	V.11	Z	V.10
EIA-530A	0	0	1	0	0	V.11	V.10	Z	V.11	V.10	V.11	Z	V.10
EIA-530	0	1	0	0	0	V.11	V.11	Z	V.11	V.11	V.11	Z	V.10
X.21	0	1	1	0	0	V.11	V.11	Z	V.11	V.11	V.11	Z	V.10
V.35	1	0	0	0	0	V.28	V.28	Z	V.28	V.28	V.28	Z	V.28
RS-449/V.36	1	0	1	0	0	V.11	V.11	Z	V.11	V.11	V.11	Z	V.10
V.28/RS-232	1	1	0	0	0	V.28	V.28	Z	V.28	V.28	V.28	Z	V.28
No cable	1	1	1	0	0	Z	Z	Z	Z	Z	Z	Z	Z
V.11	0	0	0	1	0	V.11	V.11	Z	V.11	V.11	V.11	V.10	Z
EIA-530A	0	0	1	1	0	V.11	V.10	Z	V.11	V.10	V.11	V.10	Z
EIA-530	0	1	0	0	1	V.11	V.11	Z	V.11	V.11	V.11	V.10	Z
X.21	0	1	1	0	1	V.11	V.11	Z	V.11	V.11	V.11	V.10	Z
V.35	1	0	0	0	1	V.28	V.28	Z	V.28	V.28	V.28	V.28	Z
RS-449/V.36	1	0	1	0	1	V.11	V.11	Z	V.11	V.11	V.11	V.10	Z
V.28/RS-232	1	1	0	0	1	V.28	V.28	Z	V.28	V.28	V.28	V.28	Z
No cable	1	1	1	0	1	Z	Z	Z	Z	Z	Z	Z	Z
V.11	0	0	0	1	1	V.11	V.11	V.11	Z	V.11	V.11	V.10	Z
EIA-530A	0	0	1	1	0	V.11	V.10	V.11	Z	V.10	V.11	V.10	Z
EIA-530	0	1	0	1	0	V.11	V.11	V.11	Z	V.11	V.11	V.10	Z
X.21	0	1	1	1	0	V.11	V.11	V.11	Z	V.11	V.11	V.10	Z
V.35	1	0	0	1	0	V.28	V.28	V.28	Z	V.28	V.28	V.28	Z
RS-449/V.36	1	0	1	1	0	V.11	V.11	V.11	Z	V.11	V.11	V.10	Z
V.28/RS-232	1	1	0	1	0	V.28	V.28	V.28	Z	V.28	V.28	V.28	Z
No cable	1	1	1	1	0	Z	Z	Z	Z	Z	Z	Z	Z
V.11	0	0	0	1	1	V.11	V.11	V.11	Z	V.11	V.11	V.10	Z
EIA-530A	0	0	1	1	1	V.11	V.10	V.11	Z	V.10	V.11	Z	V.10
EIA-530	0	1	0	1	1	V.11	V.11	V.11	Z	V.11	V.11	Z	V.10
X.21	0	1	1	1	1	V.11	V.11	V.11	Z	V.11	V.11	V.10	Z
V.35	1	0	0	1	1	V.28	V.28	V.28	Z	V.28	V.28	V.28	Z
RS-449/V.36	1	0	1	1	1	V.11	V.11	V.11	Z	V.11	V.11	V.10	Z
V.28/RS-232	1	1	0	1	1	V.28	V.28	V.28	Z	V.28	V.28	V.28	Z
No cable	1	1	1	1	1	Z	Z	Z	Z	Z	Z	Z	Z

Z = High impedance.

Note: Shaded areas share a single IC pin.

MAX13170E/MAX13172E/MAX13174E Evaluation Kit

Table 6. MAX13174E Termination-Mode Selection

MODE	DCE/DTE	M2	M1	M0	R1	R2	R3	R4	R5	R6
V.10/RS-423	0	0	0	0	Z	Z	Z	Z	Z	Z
EIA-530A	0	0	0	1	Z	Z	Z	V.11	V.11	V.11
EIA-530	0	0	1	0	Z	Z	Z	V.11	V.11	V.11
X.21	0	0	1	1	Z	Z	Z	V.11	V.11	V.11
V.35	0	1	0	0	V.35	V.35	Z	V.35	V.35	V.35
RS-449/V.36	0	1	0	1	Z	Z	Z	V.11	V.11	V.11
V.28/RS-232	0	1	1	0	Z	Z	Z	Z	Z	Z
No cable	0	1	1	1	V.11	V.11	V.11	V.11	V.11	V.11
V.10/RS-423	1	0	0	0	Z	Z	Z	Z	Z	Z
EIA-530A	1	0	0	1	Z	Z	Z	Z	V.11	V.11
EIA-530	1	0	1	0	Z	Z	Z	Z	V.11	V.11
X.21	1	0	1	1	Z	Z	Z	Z	V.11	V.11
V.35	1	1	0	0	V.35	V.35	V.35	Z	V.35	V.35
RS-449/V.36	1	1	0	1	Z	Z	Z	Z	V.11	V.11
V.28/RS-232	1	1	1	0	Z	Z	Z	Z	Z	Z
No cable	1	1	1	1	V.11	V.11	V.11	V.11	V.11	V.11

Z = High impedance.

Configuration

The following provides a step-by-step procedure to aid in configuring the EV kit. The EV kit is extremely flexible and has several settings for both the ICs as well as the board. The logic signals have all been routed to the 40-pin header (J1) on the left side of the board. The protocol signals have all been routed to the female DB25 connector (J2) on the right side of the board.

The chipset protocol modes can be configured to support V.28 (RS-232), V.11 (RS-449/V.36, EIA-530, EIA-530A, and X.21), and V.35 protocols. All chipset logic inputs, LED power, and shield ground connection are jumper selectable. The board includes SMA connectors (J3, J4, and J5) with optional 50Ω termination. The board settings are separated in the following sections: chipset protocol modes, clock/data transmitter input settings, control transmitter input settings, SMA termination, and power/ground.

- 1) Connect a single 5V $\pm 5\%$ power supply between the VCC and GND pads located in the lower-left corner of the EV kit board.

- 2) Chipset protocol modes:

View the desired chipset protocol modes in Tables 4, 5, and 6. Connect the jumpers to the corresponding state depending on whether the mode lines are controlled by an external controller or are

pin-strapped to a known state using Tables 7 and 8. INVERT defaults to logic-low.

- 3) Clock/data transmitter input settings:
Connect the clock/data jumpers to the corresponding state using Table 9. Force the inputs of all unused transmitters low so their corresponding LED indicators are off.
- 4) Control transmitter input settings:
Connect the control jumpers to the corresponding state using Table 10. Force the inputs of all unused transmitters low so their corresponding LED indicators are off.
- 5) SMA termination:
Connect the termination jumpers, depending on whether the signal source needs to be terminated with 50Ω , to the corresponding state using Table 11. Leave unused transmitter input lines terminated so the line is pulled down to a known state. When using SMA termination, avoid connecting JU1, JU2, and JU3 to VCC.
- 6) Power/ground:
Connect the power and ground jumpers according to the desired operation using Table 12. Leave JU17 unconnected (open) when measuring the supply current of the chipset.

MAX13170E/MAX13172E/MAX13174E

Evaluation Kit

Table 7. Chipset Protocol Mode Jumper Settings (JU13–JU16)

JUMPER	SIGNAL (BUS)	STATE	FUNCTION
JU13	DCE/DTE	Open*	Logic-high (internal pullup in the IC). The DCE/DTE line can be driven by a signal applied to J1-30 (40-pin header).
		Closed	Logic-low.
JU14	M2	Open*	Logic-high (internal pullup in the IC). The M2 line can be driven by a signal applied to J1-32 (40-pin header).
		Closed	Logic-low.
JU15	M1	Open*	Logic-high (internal pullup in the IC). The M1 line can be driven by a signal applied to J1-34 (40-pin header).
		Closed	Logic low.
JU16	M0	Open*	Logic-high (internal pullup in the IC). The M0 line can be driven by a signal applied to J1-36 (40-pin header).
		Closed	Logic-low.

*Default position.

Table 8. Invert Mode Jumper Settings (JU12)

JUMPER	SIGNAL	STATE	FUNCTION
JU12	INVERT	Open	Logic-high (internal pullup in the IC). The INVERT line can be driven by a signal applied to J1-38 (40-pin header).
		Closed*	Logic-low.

*Default position.

Table 9. Clock/Data Transmitter-Input Jumper Settings (JU1, JU2, JU3)

JUMPER	DCE/DTE	STATE	FUNCTION
JU1	RXD/TXD	1-2	Logic-high.
		2-3	Logic-low.
		Open*	Apply signal to the J5 SMA connector.
JU2	RXC/SCTE	1-2	Logic-high.
		2-3	Logic-low.
		Open*	Apply signal to the J4 SMA connector.
JU3	TXC/N/A	1-2	Logic-high.
		2-3	Logic-low.
		Open*	Apply signal to the J3 SMA connector.

*Default position.

Table 10. Control Transmitter-Input Jumper Settings (JU4–JU7)

JUMPER	DCE/DTE	STATE	FUNCTION
JU4	CTS/RTS	1-2	Logic-high.
		2-3*	Logic-low.
		Open	Apply signal to J1-14 (40-pin header).
JU5	DSR/DTR	1-2	Logic-high.
		2-3*	Logic-low.
		Open	Apply signal to J1-16 (40-pin header).
JU6	DCD/N/A	1-2	Logic-high.
		2-3*	Logic-low.
		Open	Apply signal to J1-18 (40-pin header).
JU7	LL/N/A	1-2	Logic-high.
		2-3*	Logic-low.
		Open	Apply signal to J1-26 (40-pin header).

*Default position.

MAX13170E/MAX13172E/MAX13174E

Evaluation Kit

**Table 11. Termination Jumper Settings
(JU8, JU9, JU10)**

JUMPER	DCE/DTE	STATE	FUNCTION
JU8	RXD/TXD	Open	Unterminated.
		Closed*	Terminated with 50Ω.
JU9	RXC/SCTE	Open	Unterminated.
		Closed*	Terminated with 50Ω.
JU10	TXC/N/A	Open	Unterminated.
		Closed*	Terminated with 50Ω.

*Default position.

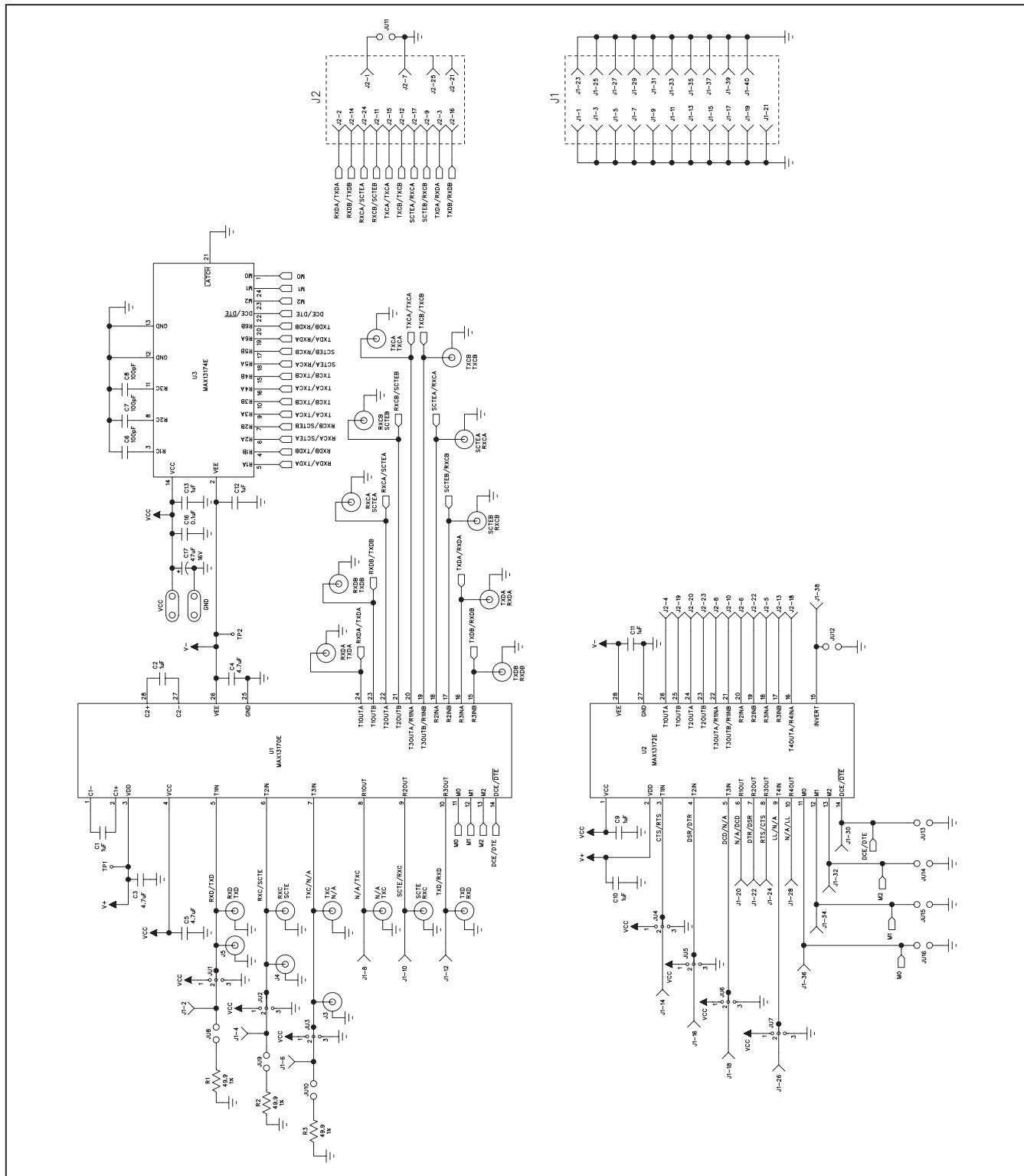
**Table 12. Power/Ground Jumper Settings
(JU11, JU17)**

JUMPER	NAME	STATE	FUNCTION
JU11	SHIELD	Open	DB25 cable shield disconnected from signal ground.
		Closed*	DB25 cable shield shorted to signal ground.
JU17	LED ANODE	Open	LED anode is unconnected.
		Closed*	LED anode is connected to VCC.

*Default position.

Evaluates: MAX13170E/MAX13172E/MAX13174E

MAX13170E/MAX13172E/MAX13174E Evaluation Kit



MAX13170E/MAX13172E/MAX13174E Evaluation Kit

Evaluates: MAX13170E/MAX13172E/MAX13174E

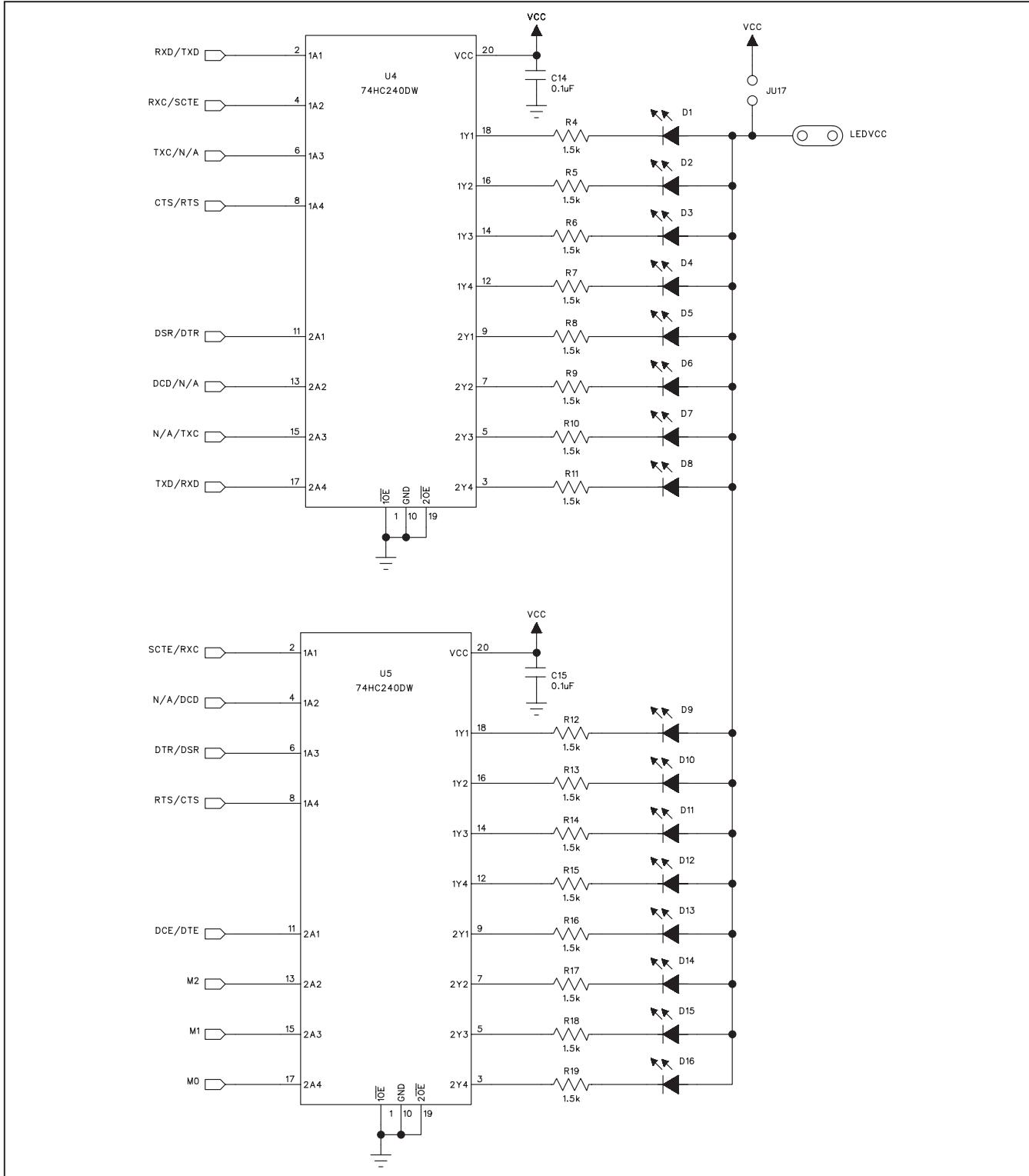


Figure 1b. MAX13171E/MAX13173E/MAX13175E EV Kit Schematic (Sheet 2 of 2)

Evaluates: MAX13170E/MAX13172E/MAX13174E

MAX13170E/MAX13172E/MAX13174E Evaluation Kit

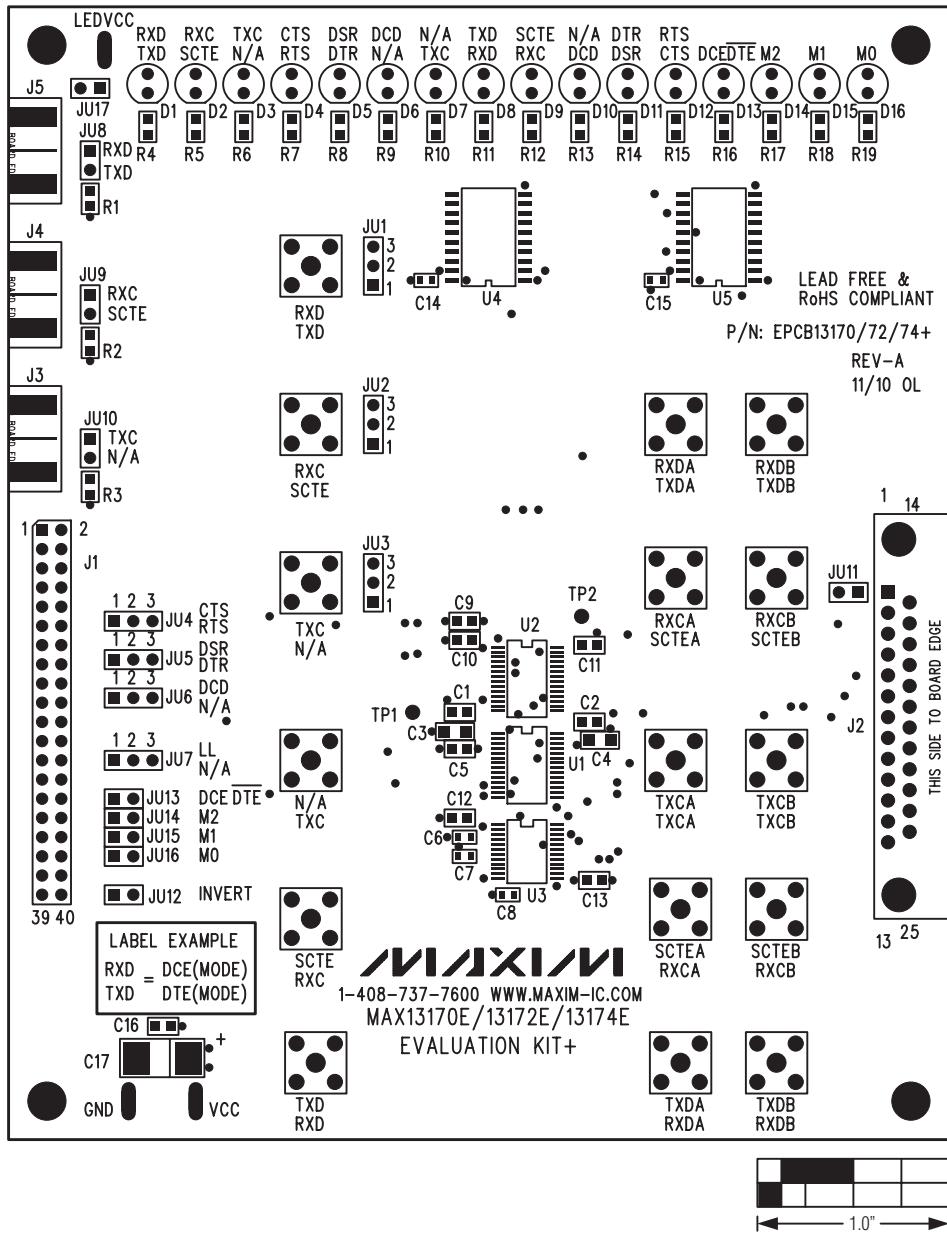


Figure 2. MAX13170E/MAX13172E/MAX13174E EV Kit Component Placement Guide—Component Side

MAX13170E/MAX13172E/MAX13174E

Evaluation Kit

Evaluates: MAX13170E/MAX13172E/MAX13174E

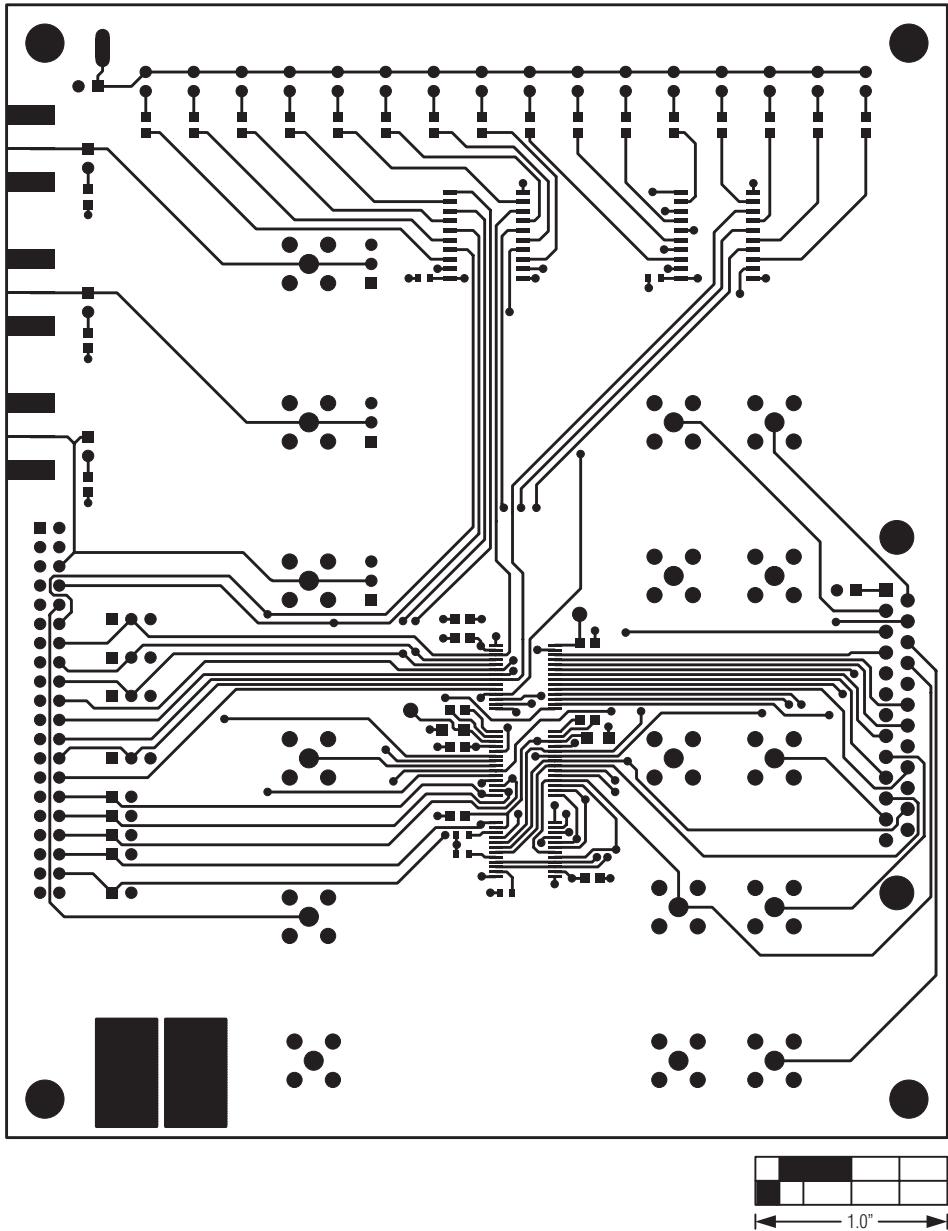


Figure 3. MAX13170E/MAX13172E/MAX13174E EV Kit PCB Layout—Component Side

MAX13170E/MAX13172E/MAX13174E Evaluation Kit

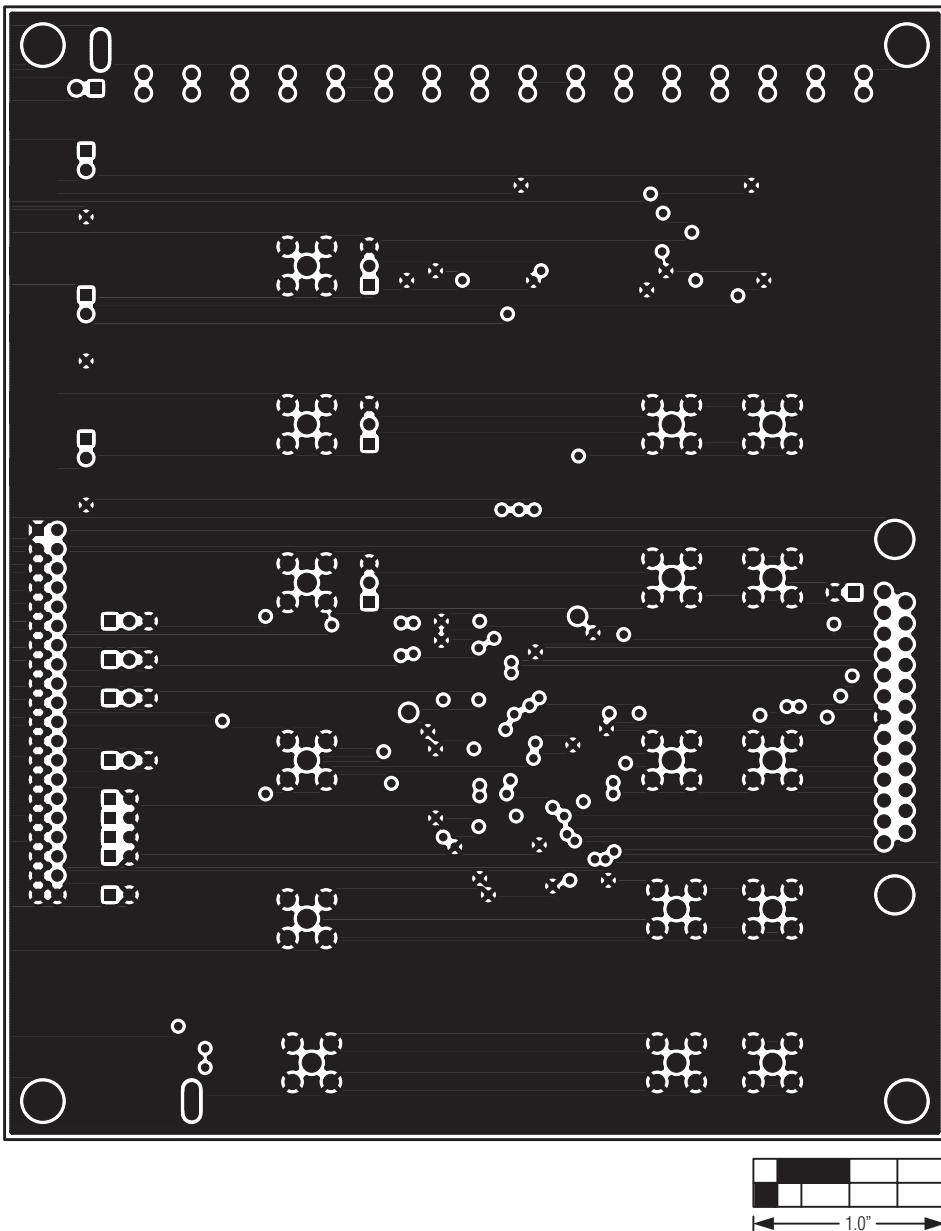


Figure 4. MAX13170E/MAX13172E/MAX13174E EV Kit PCB Layout—Inner Layer 2

MAX13170E/MAX13172E/MAX13174E

Evaluation Kit

Evaluates: MAX13170E/MAX13172E/MAX13174E

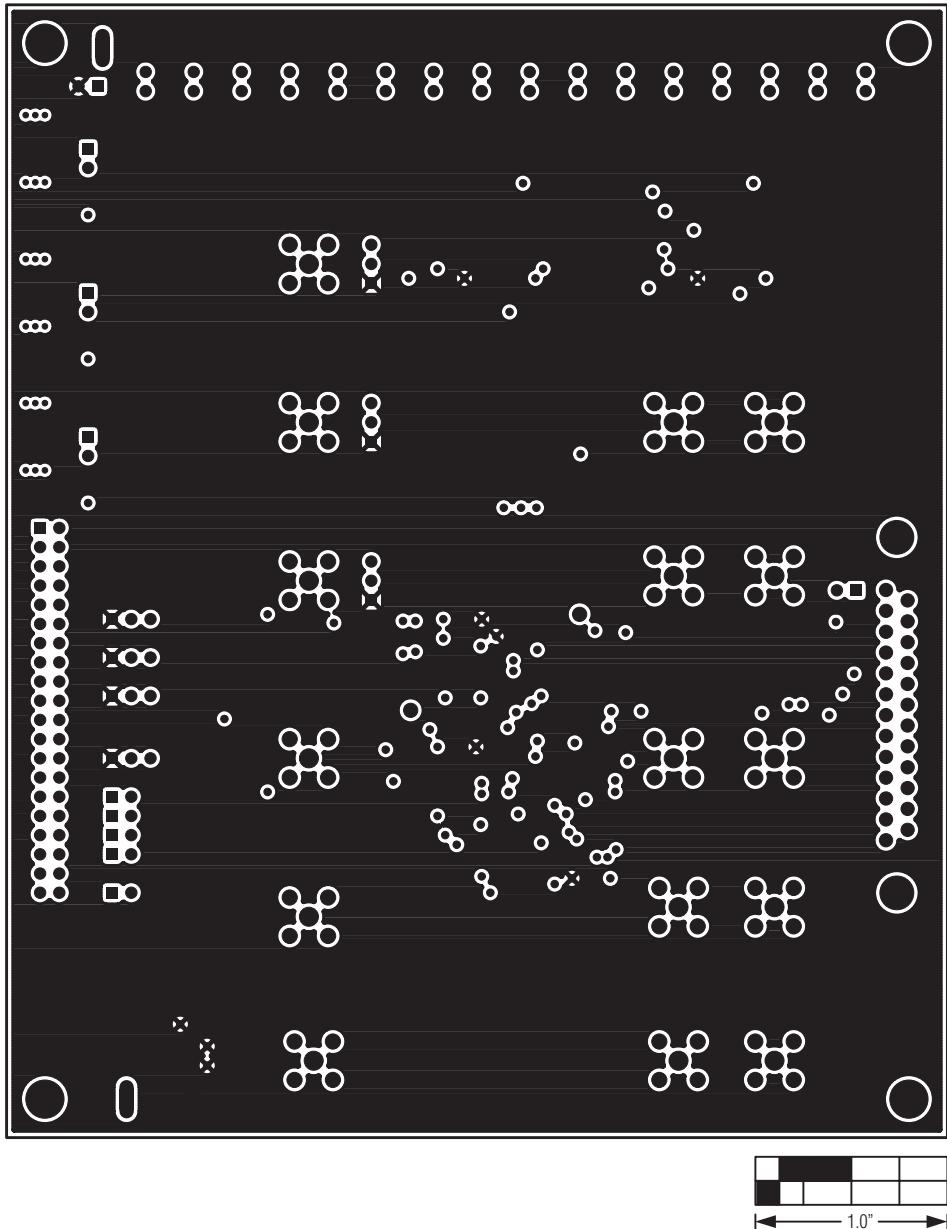


Figure 5. MAX13170E/MAX13172E/MAX13174E EV Kit PCB Layout—Inner Layer 3

Evaluates: MAX13170E/MAX13172E/MAX13174E

MAX13170E/MAX13172E/MAX13174E Evaluation Kit

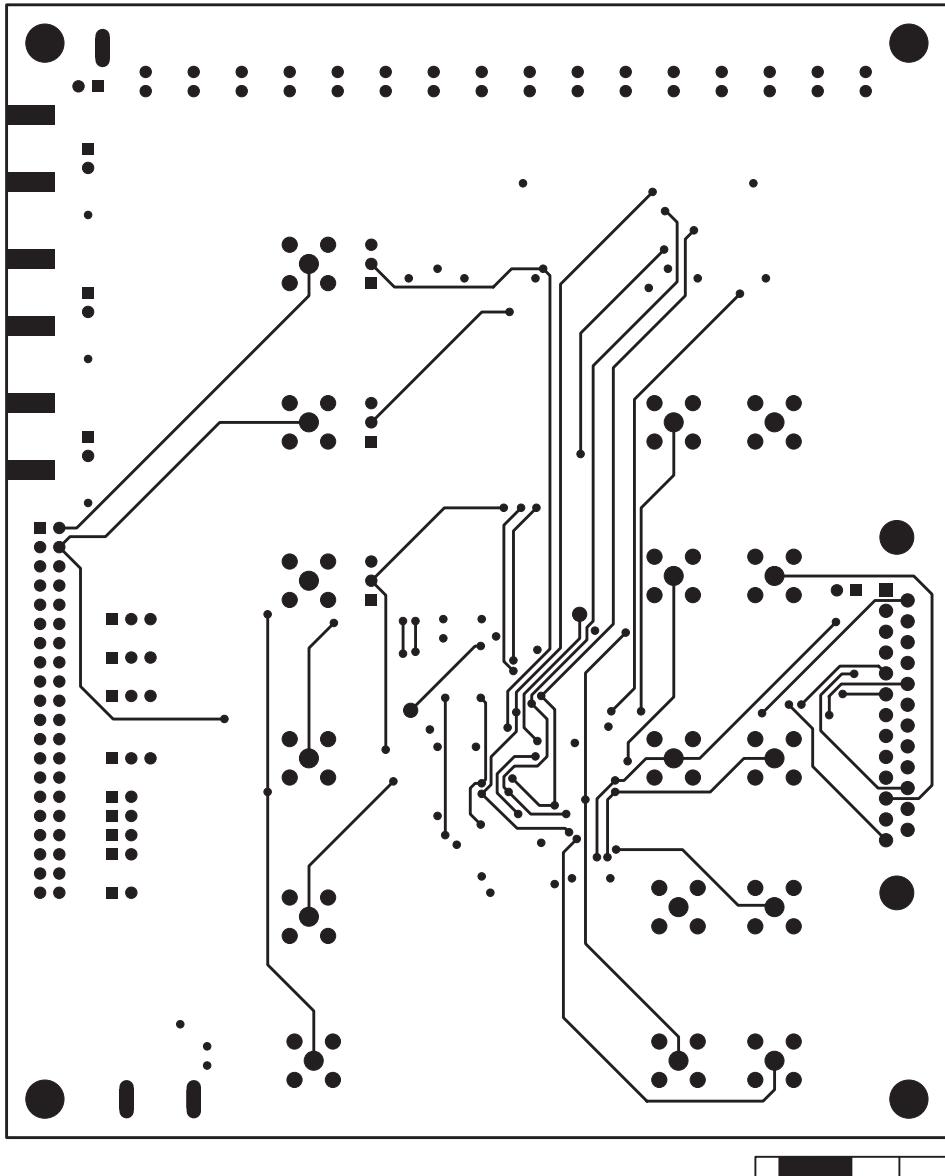


Figure 6. MAX13170E/MAX13172E/MAX13174E EV Kit PCB Layout—Solder Side

MAX13170E/MAX13172E/MAX13174E

Evaluation Kit

Revision History

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	1/11	Initial release	—

Maxim cannot assume responsibility for use of any circuitry other than circuitry entirely embodied in a Maxim product. No circuit patent licenses are implied. Maxim reserves the right to change the circuitry and specifications without notice at any time.

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